



60V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BVDSS	R _{DS(ON)} Max	I _D Max T _A = +25°C		
00)/	5mΩ @ V _{GS} = 10V	17.0A		
60V	$6.9 \text{m}\Omega$ @ V _{GS} = 4.5V	14.5A		

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

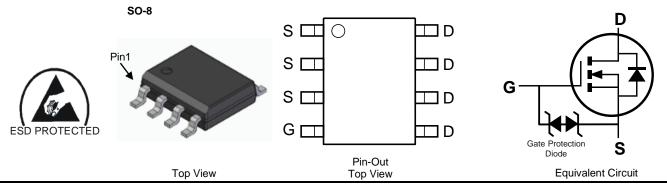
- High Frequency Switching
- Synchronous Rectification
- DC-DC Converters

Features and Benefits

- 100% Unclamped Inductive Switching (UIS) Test in Production— Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low Rds(ON)—Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208
- Weight: 0.076 grams (Approximate)



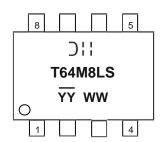
Ordering Information (Note 4)

Part Number	Case	Packaging
DMT64M8LSS-13	SO-8	2.500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



);; = Manufacturer's Marking
T64M8LS = Product Type Marking Code
YYWW = Date Code Marking
YY = Year (ex: 20 = 2020)
WW = Week (01 to 53)

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	60	V		
Gate-Source Voltage		V _{GSS}	±20	V	
Continuous Durin Comment (Note 5) \/ 40\/	T _A = +25°C	-	13.6	A	
Continuous Drain Current (Note 5) Vss = 10V	T _A = +70°C	lD	10.9		
TA			17.0	۸	
Continuous Drain Current (Note 6) V _G s = 10V	T _A = +70°C	lD	13.6	Α	
Maximum Continuous Body Diode Forward Current (Note 6)	Is	17.0	А		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	130	А		
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1	lsм	130	А		
Avalanche Current, L = 0.3mH	las	27.2	А		
Avalanche Energy, L = 0.3mH	Eas	111	mJ		

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	1.4	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Rөja	89.5	°C/W
Total Power Dissipation (Note 6) $T_A = +25^{\circ}C$		PD	2.2	W
Thermal Resistance, Junction to Ambient (Note 6) Steady State		Rөja	57.5	°C/W
Thermal Resistance, Junction to Case (Note 6)	Rejc	6.5	°C/W	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics ($T_A = +25^{\circ}C$, unless otherwise specified.)

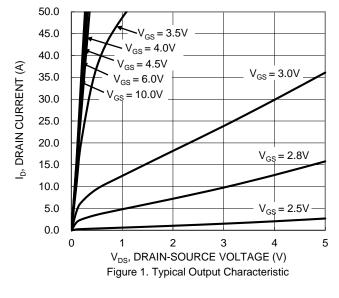
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	60	_		V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}		_	1	μΑ	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	l	_	±10	μΑ	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(TH)	1.3	_	2.3	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	Process		3.9	5	mΩ	$V_{GS} = 10V, I_{D} = 20A$	
Static Drain-Source Off-Resistance	Rds(on)		5.3	6.9		$V_{GS} = 4.5V$, $I_{D} = 12.5A$	
Diode Forward Voltage	VsD		8.0	1.2	V	Vgs = 0V, Is = 20A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	l	2664	1		V _{DS} = 30V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss		955	-	pF		
Reverse Transfer Capacitance	C _{rss}	l	75	1			
Gate Resistance	Rg		0.76	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_g	l	26.1	l			
Total Gate Charge (V _{GS} = 10V)	Qg	l	47.5	l	nC	Vpp = 30V. Ip = 20A	
Gate-Source Charge	Qgs	l	6.2	l	IIC	VDD = 30V, ID = 20A	
Gate-Drain Charge	Q_{gd}		12.5	1			
Turn-On Delay Time	tD(ON)	l	6.4	l		$\begin{split} V_{DD} &= 30 \text{V}, \ V_{GS} = 10 \text{V}, \\ I_D &= 20 \text{A}, \ R_g = 3.3 \Omega \end{split}$	
Turn-On Rise Time	t _R		9.1	1	ns		
Turn-Off Delay Time	tD(OFF)		29.8	1	115		
Turn-Off Fall Time	tF		18.3	-			
Body Diode Reverse Recovery Time	t _{RR}		41		ns I 200 di/dt 1000//cc		
Body Diode Reverse Recovery Charge	Q _{RR}	_	53	_	nC	I _F = 20A, di/dt = 100A/μs	

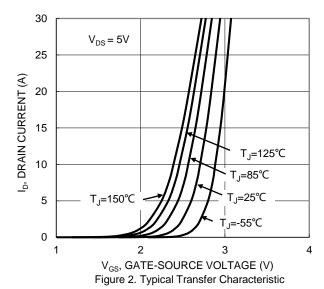
- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.

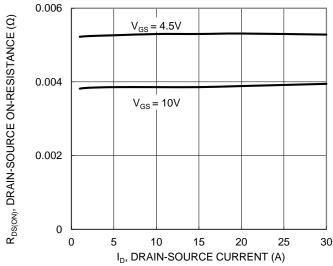
- 8. Guaranteed by design. Not subject to product testing.

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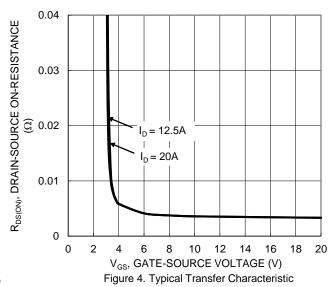


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

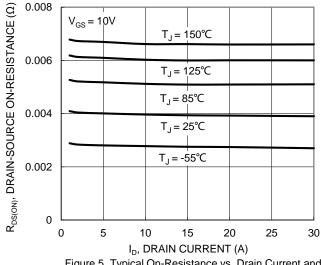
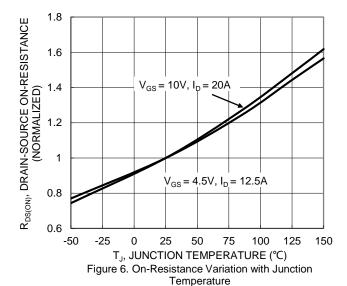


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





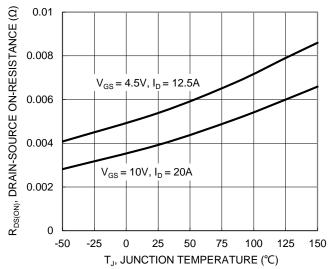


Figure 7. On-Resistance Variation with Junction Temperature

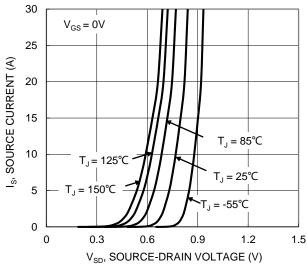


Figure 9. Diode Forward Voltage vs. Current

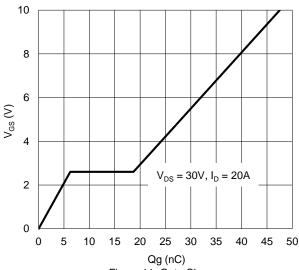


Figure 11. Gate Charge

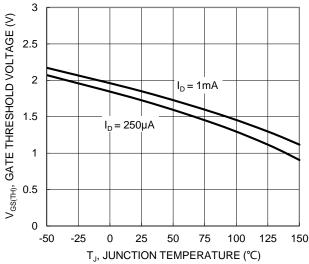
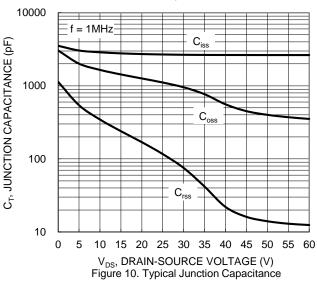


Figure 8. Gate Threshold Variation vs. Junction Temperature



1000 $P_W = 100 \mu s$ 100 DRAIN CURRENT (A) 10 P_w =1ms T_{J(Max)} = 150°C =10ms T_A = 25 °C P_W =100ms P_W =1 0.1 فــ Single Pulse DUT on $P_W = 10s$ 1*MRP Board DC $V_{GS} = 10V$ 0.01 0.01 100 $V_{\rm DS}$, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



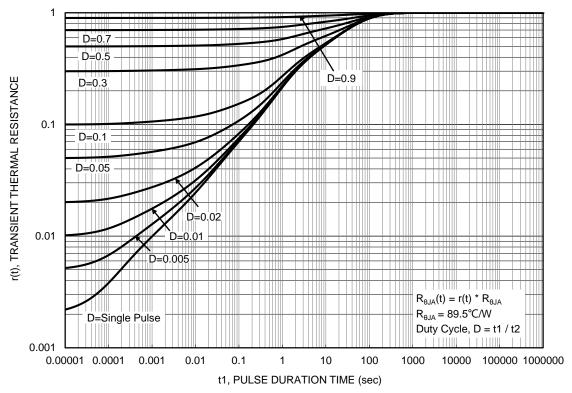


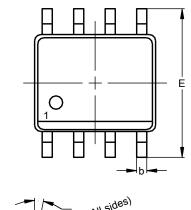
Figure 13. Transient Thermal Resistance

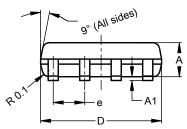


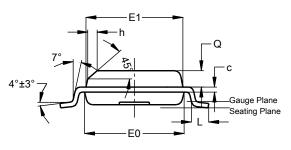
Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8





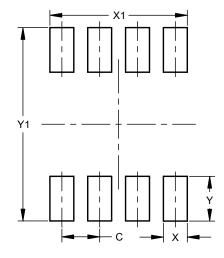


SO-8					
Dim	Min	Max	Тур		
Α	1.40	1.50	1.45		
A1	0.10	0.20	0.15		
b	0.30	0.50	0.40		
С	0.15	0.25	0.20		
D	4.85	4.95	4.90		
Е	5.90	6.10	6.00		
E1	3.80	3.90	3.85		
E0	3.85	3.95	3.90		
е			1.27		
h			0.35		
L	0.62	0.82	0.72		
Q	0.60	0.70	0.65		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

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Dimensions	Value (in mm)			
С	1.27			
Х	0.802			
X1	4.612			
Υ	1.505			
Y1	6.50			



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